

| Basic information | |
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| <p>2013/2905(DEA) DEA - Delegated acts procedure</p> <p>Exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below -20°C</p> <p>Supplementing 2008/0240(COD)</p> <p>Subject</p> <p>3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)</p> | <p>Procedure completed - delegated act enters into force</p> |

| Documentation gateway | | | |
|--------------------------------|------------------------------|------------|---------|
| European Commission | | | |
| Document type | Reference | Date | Summary |
| Non-legislative basic document | C(2013)06798 | 18/10/2013 | |